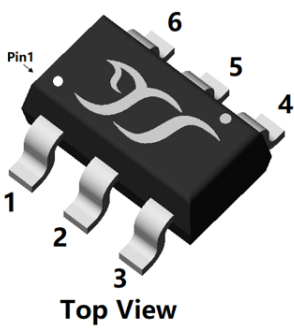
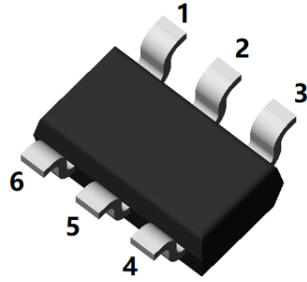


## N-Channel Enhancement Mode Field Effect Transistor

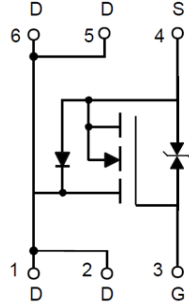


Top View



Bottom View

**SOT-23-6L**



### Product Summary

- $V_{DS}$  30V
- $I_D$  1.4A
- $R_{DS(ON)}$ ( at  $V_{GS}=4.5V$ )  $<260m\Omega$
- $R_{DS(ON)}$ ( at  $V_{GS}=2.5V$ )  $<400m\Omega$
- ESD Protected Up to 3KV(HBM)

### General Description

- Voltage controlled small signal switch
- Low input Capacitance
- Fast Switching Speed
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- Battery operated systems
- Solid-state relays
- Direct logic-level interface:TTL/CMOS

### Limiting Values

Parameter	Conditions		Symbol	Min	Max	Unit
Drain-source Voltage			$V_{DS}$	-	30	V
Gate-source Voltage			$V_{GS}$	-10	10	
Continuous Drain Current (Note 1,2)	Steady-State	$T_A=25^\circ C, V_{GS}=10V$	$I_D$	-	1.4	A
		$T_A=100^\circ C, V_{GS}=10V$		-	0.9	
Pulsed Drain Current	$T_A=25^\circ C, t_p \leq 10\mu s$		$I_{DM}$	-	6	
Maximum Body-Diode Continuous Current	$T_A=25^\circ C$		$I_S$		1	
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25^\circ C$	$P_D$	-	1	W
		$T_A=100^\circ C$		-	0.4	
Junction and Storage Temperature Range			$T_J, T_{STG}$	-55	150	$^\circ C$

### Thermal Resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	Steady-State	$R_{\theta JA}$	-	125	$^\circ C/W$

### Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJJ260N03AK	F2	260AJ	3000	30000	120000	7" reel



# YJJ260N03AK

## ■ Electrical Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A, T_j=25^\circ C$	30	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=30V, V_{GS}=0V, T_j=25^\circ C$	-	-	1	$\mu A$
		$V_{DS}=30V, V_{GS}=0V, T_j=150^\circ C$	-	-	100	
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 10V, V_{DS}=0V, T_j=25^\circ C$	-	-	$\pm 10$	$\mu A$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A, T_j=25^\circ C$	0.45	0.75	1	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=1.4A, T_j=25^\circ C$	-	205	260	$m\Omega$
		$V_{GS}=2.5V, I_D=0.7A, T_j=25^\circ C$	-	240	400	$m\Omega$
Diode Forward Voltage	$V_{SD}$	$I_S=1A, V_{GS}=0V, T_j=25^\circ C$	-	0.86	1.2	V
Gate Resistance	$R_G$	$f=1MHz, T_j=25^\circ C$	-	5	-	$\Omega$
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=15V, V_{GS}=0V, f=1MHz, T_j=25^\circ C$	-	58	-	$\mu F$
Output Capacitance	$C_{oss}$		-	9.8	-	
Reverse Transfer Capacitance	$C_{rss}$		-	5.1	-	
<b>Switching Parameters</b>						
Total Gate Charge	$Q_g$	$V_{GS}=4.5V, V_{DS}=15V, I_D=1.4A, T_j=25^\circ C$	-	0.9	-	$nC$
Gate-Source Charge	$Q_{gs}$		-	0.2	-	
Gate-Drain Charge	$Q_{gd}$		-	0.3	-	
Reverse Recovery Charge	$Q_{rr}$	$I_F=1.4A, di/dt=100A/\mu s, V_{GS}=0V, V_R=15V, T_j=25^\circ C$	-	5.3	-	$nC$
Reverse Recovery Time	$t_{rr}$		-	16	-	ns
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=4.5V, V_{DS}=15V, I_D=1.4A, R_{GEN}=3\Omega, T_j=25^\circ C$	-	3.7	-	$ns$
Turn-on Rise Time	$t_r$		-	5.9	-	
Turn-off Delay Time	$t_{D(off)}$		-	10.4	-	
Turn-off Fall Time	$t_f$		-	4	-	

### Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of  $R_{\theta JA}$  is measured with the device mounted on the 40mm\*40mm\*1.1mm single layer FR-4 PCB board with 1 in<sup>2</sup> pad of 2oz. Copper, in the still air environment with  $T_A=25^\circ C$ . The maximum allowed junction temperature of 150 $^\circ C$ . The value in any given application depends on the user's specific board design.



## Typical Electrical and Thermal Characteristics Diagrams

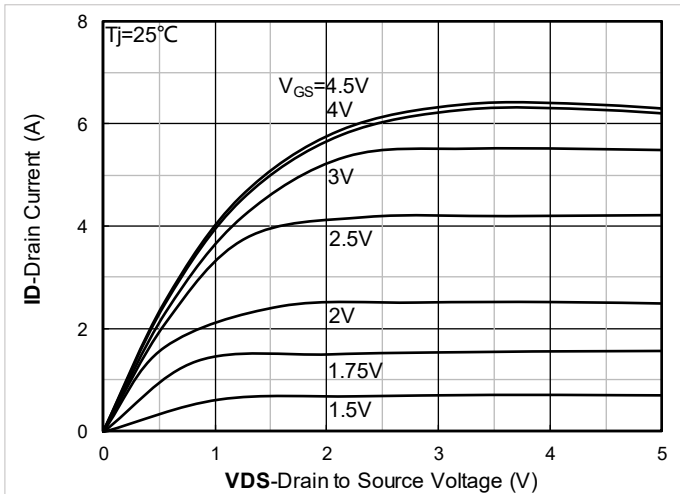


Figure 1. Output Characteristics; typical values

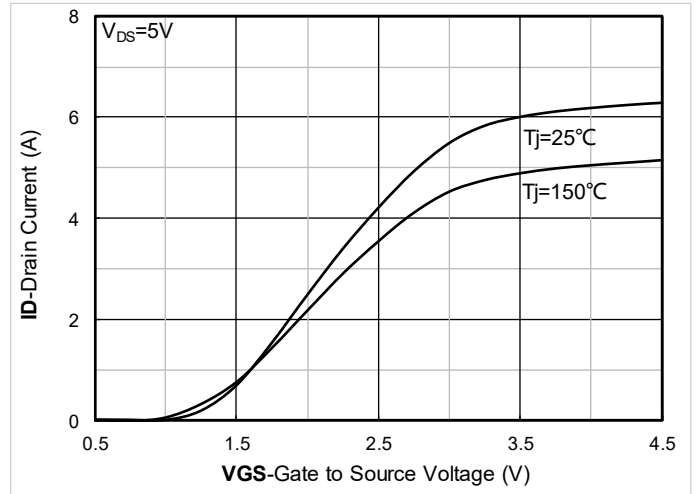


Figure 2. Transfer Characteristics; typical values

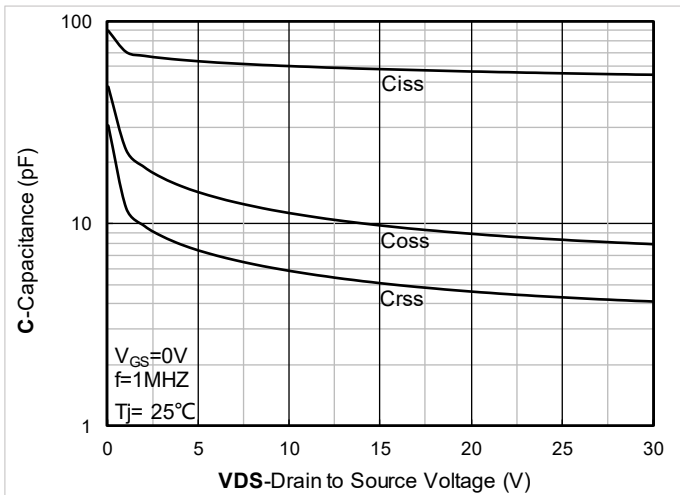


Figure 3. Capacitance Characteristics; typical values

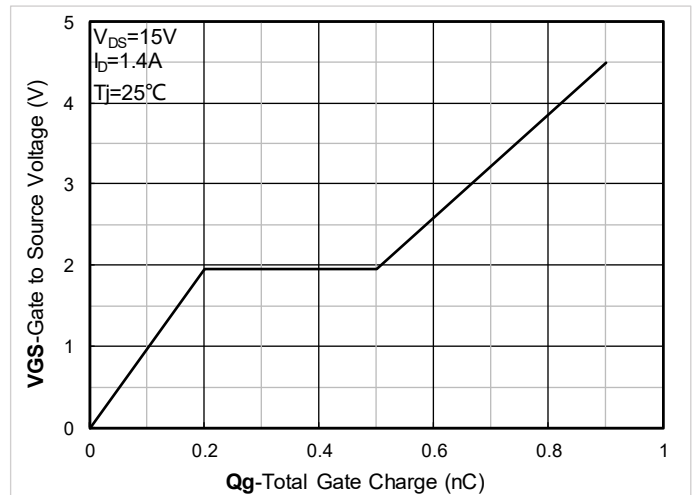


Figure 4. Gate Charge; typical values

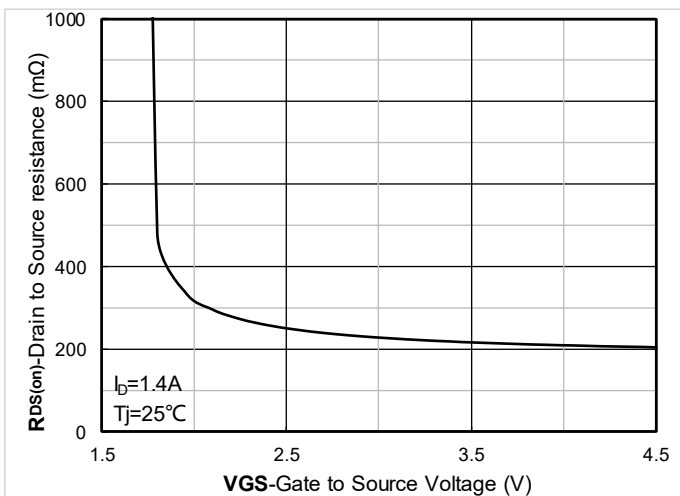


Figure 5. On-Resistance vs. Gate to Source Voltage; typical values

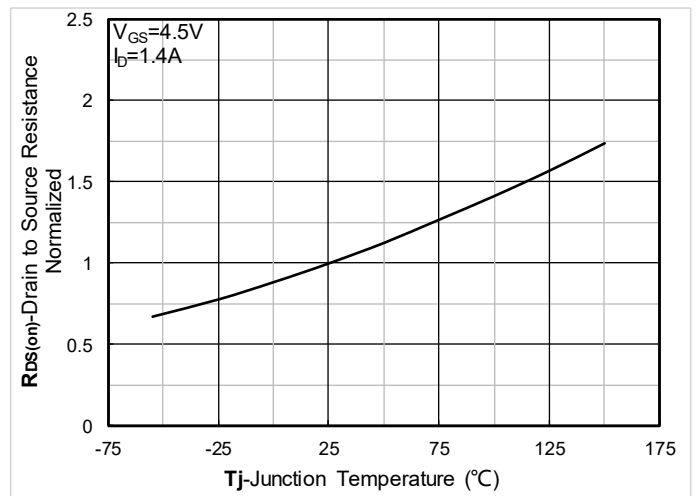


Figure 6. Normalized On-Resistance



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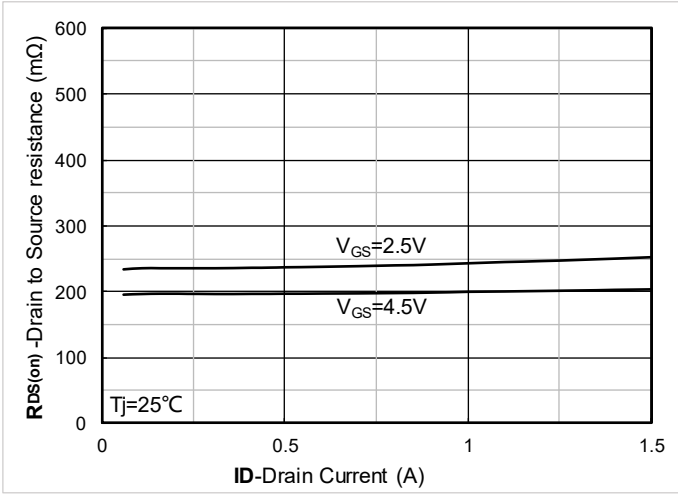


Figure 7. RDS(on) vs. Drain Current; typical values

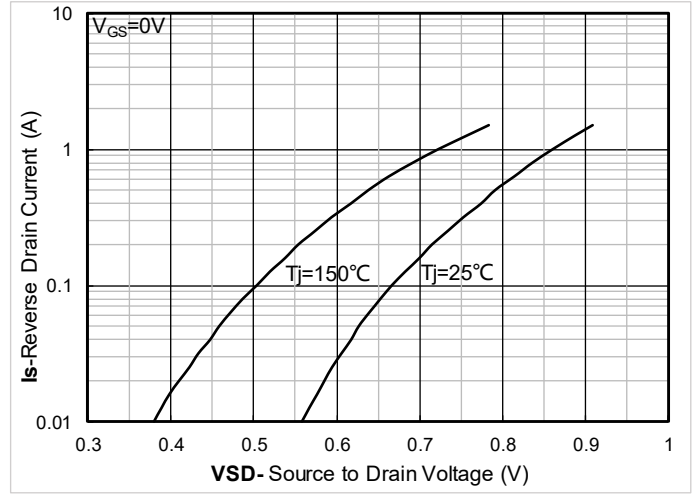


Figure 8. Forward characteristics of reverse diode; typical values

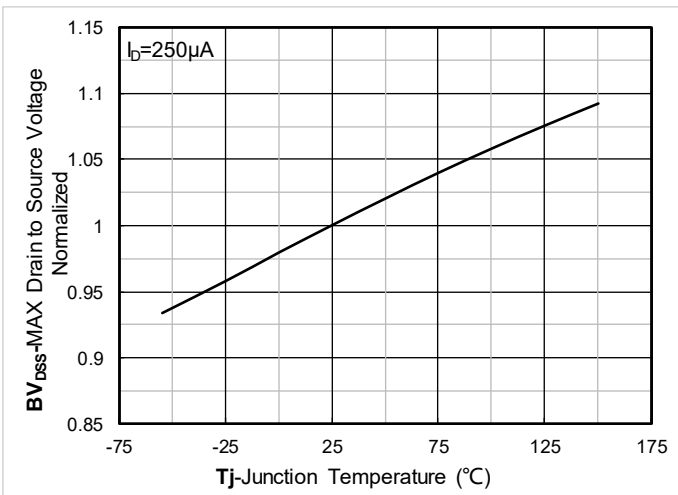


Figure 9. Normalized breakdown voltage

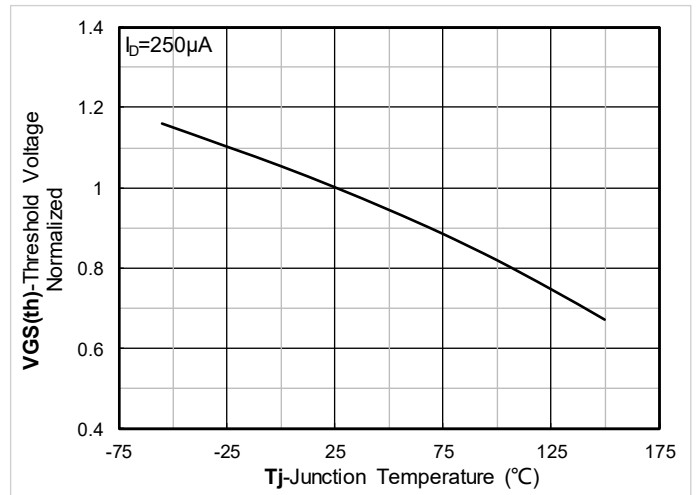


Figure 10. Normalized Threshold voltage

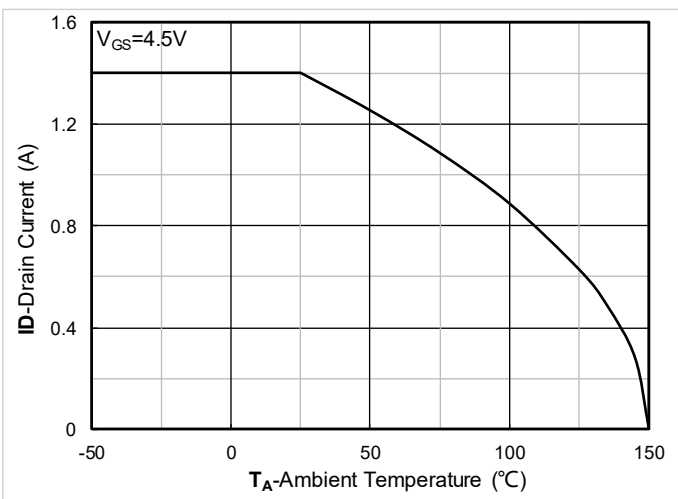


Figure 11. Current dissipation

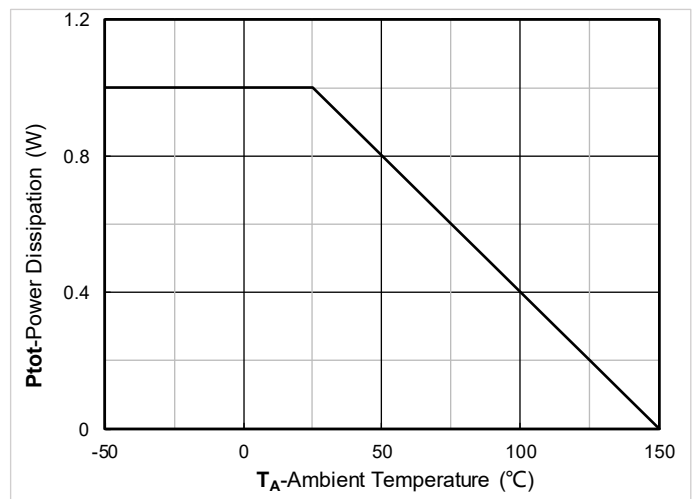


Figure 12. Power dissipation



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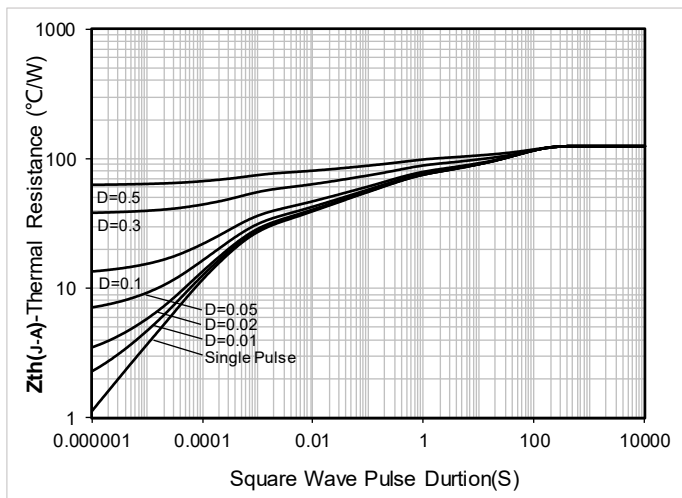


Figure 13. Maximum Transient Thermal Impedance

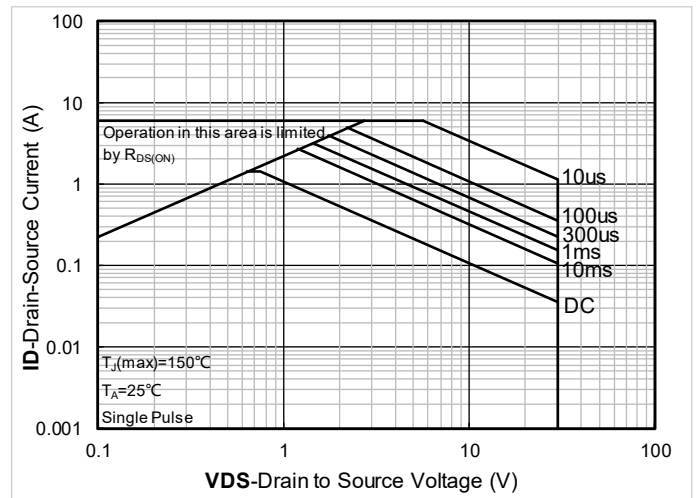


Figure 14. Safe Operation Area

## ■ Test Circuits & Waveforms

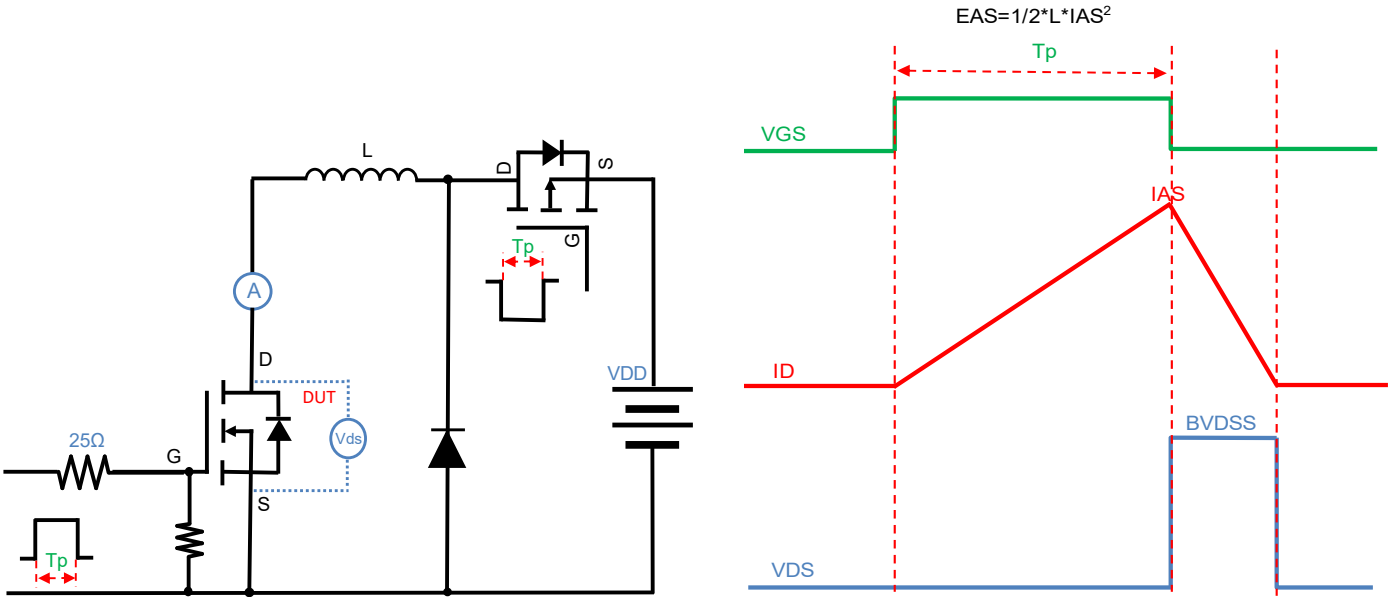


Figure A. Unclamped Inductive Switching (UIS) Test Circuit & Waveform

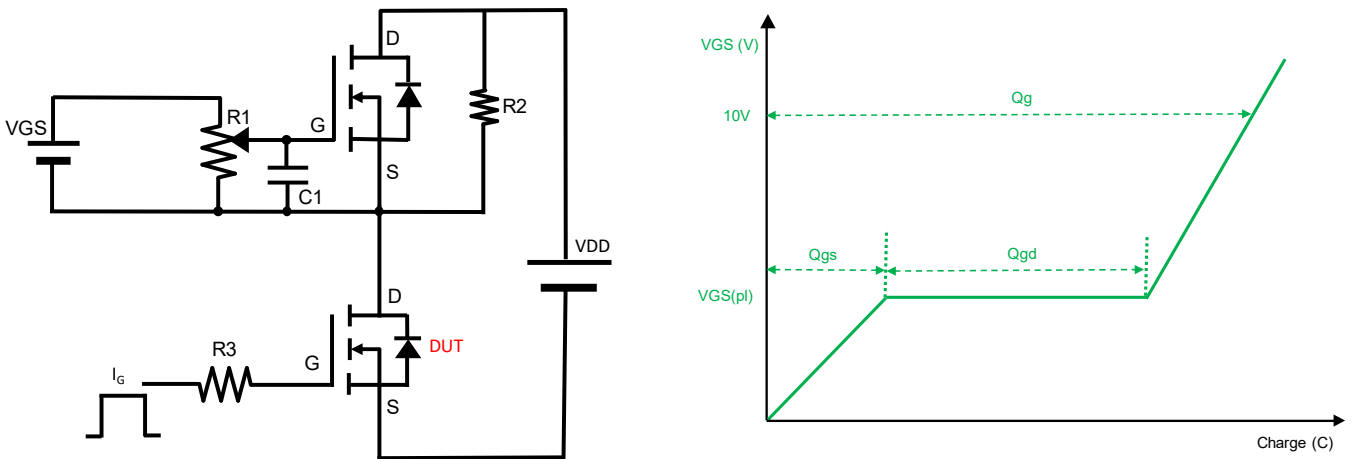


Figure B. Gate Charge Test Circuit & Waveform

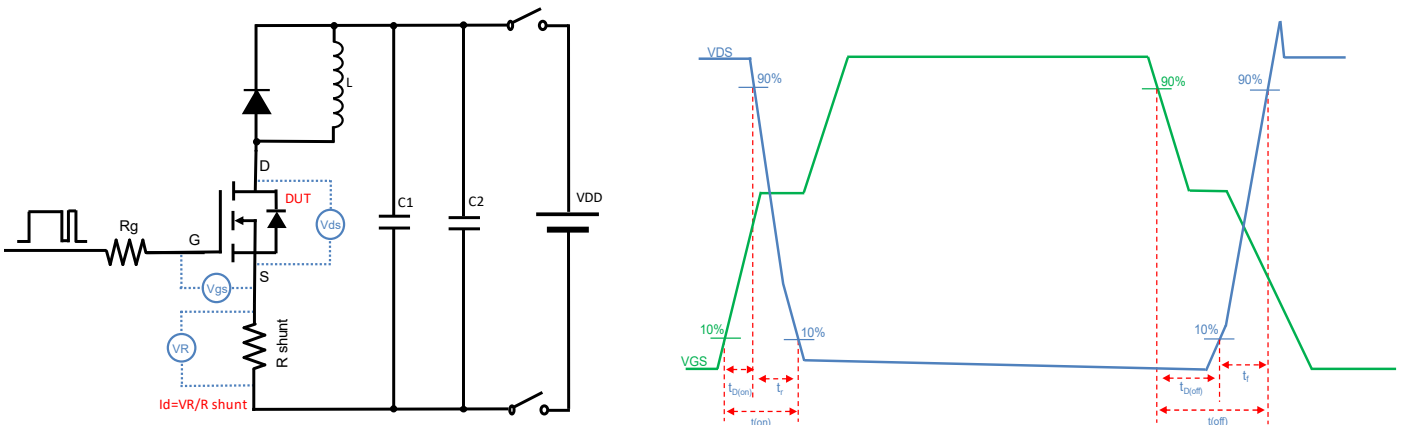


Figure C. Resistive Switching Test Circuit & Waveform

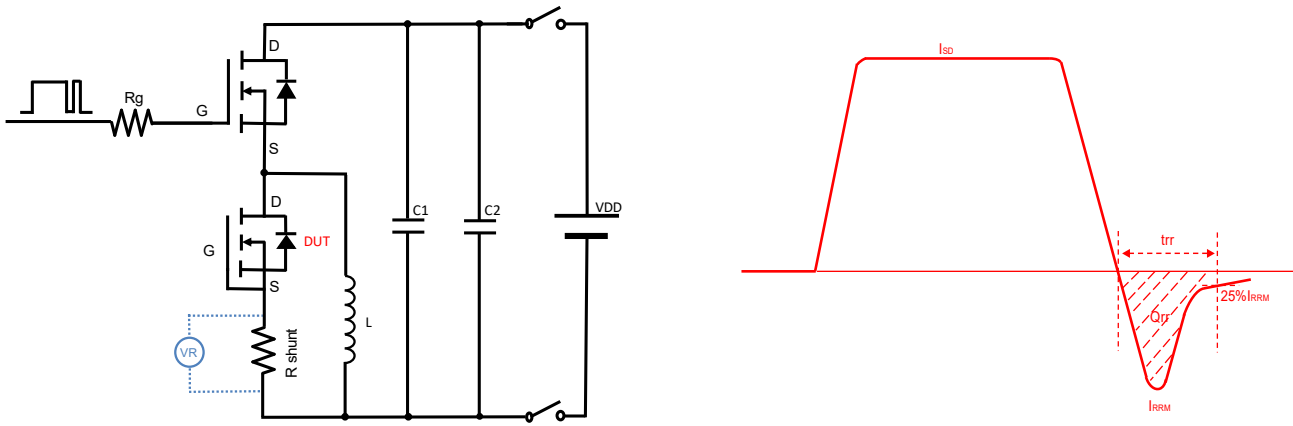
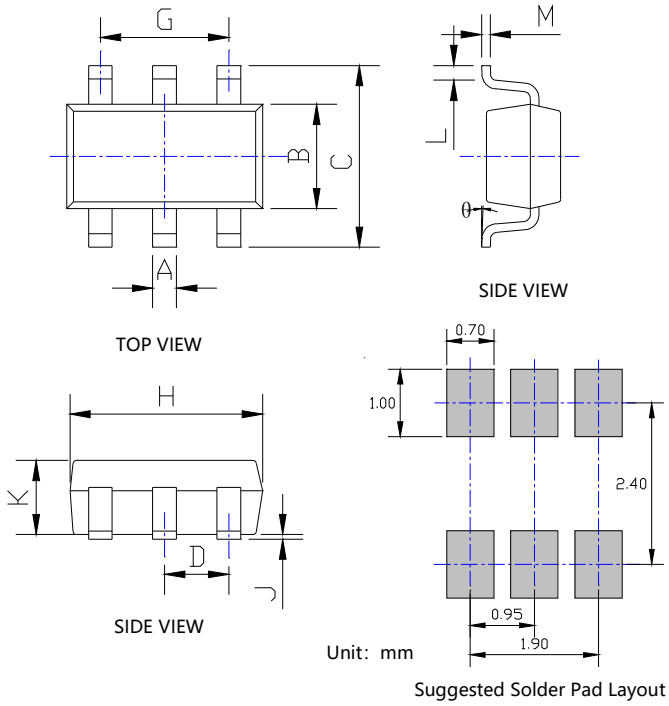


Figure D. Diode Recovery Test Circuit & Waveform



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## ■ SOT-23-6L Package information



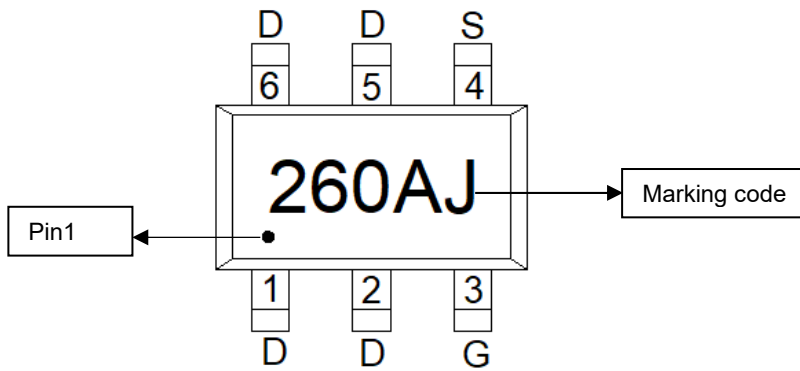
SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.012	0.020	0.300	0.500
B	0.059	0.067	1.500	1.700
C	0.104	0.116	2.650	2.950
D	0.037BSC		0.950BSC	
G	0.075BSC		1.900BSC	
H	0.111	0.119	2.820	3.020
J	0.000	0.004	0.000	0.100
K	0.041	0.045	1.050	1.150
L	0.012	0.024	0.300	0.600
M	0.004	0.008	0.100	0.200
$\theta$	0°	8°	0°	8°

### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05$  mm.
3. The pad layout is for reference purposes only.



## ■ Marking Information



**Note:**

1. All marking is at middle of the product body
2. All marking is in laser printing
3. 260AJ is marking code
4. Body color: Black



# YJJ260N03AK

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